

## AMENDMENTS TO THE SPECIFICATION

On page 8, please amend paragraph [32] as follows:

[32] Reference numeral ~~[[2]]~~ 21 denotes a first underlayer ~~21~~ or what may be considered an adhesion layer, typically containing Ti or a Ti alloy, and having a thickness up to about 50Å. Second underlayer 22, which may be considered a soft magnetic underlayer, is typically formed at a thickness of 500Å to 4000Å and may comprise Ni, NiFe (Permalloy), Co, CoZr, CoZrCr, CoZrNb, CoFeZrNb, CoFe, Fe, FeN, FeSiAl, FeSiAlN, FeCoB or FeCoC. Optional third underlayer 23 is typically formed at a thickness of 10Å to 30Å and may comprise an alloy or metal, such as Ag.

Please amend paragraph [38] bridging pages 9 and 10 as follows:

[38] In Table I: ~~M<sub>r</sub>~~ M<sub>r</sub>T denotes magnetic remanance times thickness; I<sub>w</sub> denotes writing current; LF denotes low frequency signal; MF denotes mid frequency signal; Mod denotes modulation; OW denotes overwrite; PW50 denotes half pulse width; S denotes integrated signal; N<sub>el</sub> denotes electronic noise; and eSMNR(f) denotes equalized signal to medium noise ratio frequency domain.